



FQB7P20TM_F085

200V P-Channel MOSFET

General Description

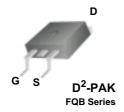
These P-Channel enhancement mode power field effect transistors are produced using Fairchild's proprietary, planar stripe, DMOS technology.

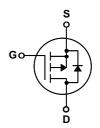
This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency switching DC/DC converters.

Features

- -7.3A, -200V, $R_{DS(on)} = 0.69\Omega$ @ $V_{GS} = -10 V$
- Low gate charge (typical 19 nC)
- Low Crss (typical 25 pF)
- · Fast switching
- 100% avalanche tested
- · Improved dv/dt capability
- Qualified to AEC Q101
- RoHS Compliant







Absolute Maximum Ratings T_C = 25°C unless otherwise noted

Symbol	Parameter		Ratings	Units	
V _{DSS}	Drain-Source Voltage		-200	V	
I _D	Drain Current - Continuous (T _C = 25°C) - Continuous (T _C = 100°C)		-7.3	Α	
			-4.6	А	
I _{DM}	Drain Current - Pulsed	(Note 1)	-29.2	Α	
V _{GSS}	Gate-Source Voltage		± 30	V	
E _{AS}	Single Pulsed Avalanche Energy	anche Energy (Note 2)		mJ	
I _{AR}	Avalanche Current	(Note 1)	-7.3	Α	
E _{AR}	Repetitive Avalanche Energy	(Note 1)	9.0	mJ	
dv/dt	Peak Diode Recovery dv/dt	(Note 3)	-5.5	V/ns	
P _D	Power Dissipation (T _A = 25°C) *		3.13	W	
	Power Dissipation (T _C = 25°C)		90	W	
	- Derate above 25°C		0.72	W/°C	
T _J , T _{STG}	Operating and Storage Temperature Range		-55 to +150	°C	
T _L	Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds		300	°C	

Thermal Characteristics

Symbol	Parameter	Тур	Max	Units
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case		1.39	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient *		40	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient		62.5	°C/W

^{*} When mounted on the minimum pad size recommended (PCB Mount)

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Cha	aracteristics					
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} = 0 V, I _D = -250 μA	-200			V
ΔBV _{DSS} / ΔT _J	Breakdown Voltage Temperature Coefficient	I _D = -250 μA, Referenced to 25°C		-0.1		V/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = -200 V, V _{GS} = 0 V			-1	μΑ
		V _{DS} = -160 V, T _C = 125°C			-10	μΑ
I _{GSSF}	Gate-Body Leakage Current, Forward	V _{GS} = -30 V, V _{DS} = 0 V			-100	nA
I _{GSSR}	Gate-Body Leakage Current, Reverse	V _{GS} = 30 V, V _{DS} = 0 V			100	nA
On Cha	racteristics					
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	-3.0		-5.0	V
R _{DS(on)}	Static Drain-Source On-Resistance	V _{GS} = -10 V, I _D = -3.65 A		0.54	0.69	Ω
9 _{FS}	Forward Transconductance	V _{DS} = -40 V, I _D = -3.65 A (Note 4)		4.4		S
C _{iss}	Input Capacitance Output Capacitance Poverse Transfer Capacitance	$V_{DS} = -25 \text{ V}, V_{GS} = 0 \text{ V},$ f = 1.0 MHz		590 140 25	770 180 35	pF pF pF
C _{rss} Switchi	Reverse Transfer Capacitance			25	35	pr
t _{d(on)}	Turn-On Delay Time	V - 400 V I - 7.2 A		15	40	ns
t _r	Turn-On Rise Time	$V_{DD} = -100 \text{ V}, I_{D} = -7.3 \text{ A},$ $R_{G} = 25 \Omega$		110	230	ns
t _{d(off)}	Turn-Off Delay Time	1 KG - 23 22		30	70	ns
t _f	Turn-Off Fall Time	(Note 4, 5)		42	90	ns
Qg	Total Gate Charge	V _{DS} = -160 V, I _D = -7.3 A,		19	25	nC
Q _{gs}	Gate-Source Charge	V _{GS} = -10 V		4.6		nC
Q _{gd}	Gate-Drain Charge	(Note 4, 5)		9.5		nC
Drain-S	ource Diode Characteristics a	nd Maximum Ratings				
I _S	Maximum Continuous Drain-Source Diode Forward Current				-7.3	Α
I _{SM}	Maximum Pulsed Drain-Source Diode F			-	-29.2	Α
V_{SD}	Drain-Source Diode Forward Voltage	$V_{GS} = 0 \text{ V}, I_{S} = -7.3 \text{ A}$			-5.0	V
		1				. —
t _{rr}	Reverse Recovery Time	$V_{GS} = 0 \text{ V}, I_{S} = -7.3 \text{ A},$ $dI_{C} / dt = 100 \text{ A/us} \qquad \text{(Note 4)}$		180		ns

- **Notes:**1. Repetitive Rating : Pulse width limited by maximum junction temperature 2. L = 16mH, l_{AS} = -7.3A, V_{DD} = -50V, R_{G} = 25 Ω , Starting T_{J} = 25°C 3. $l_{SD} \leq$ -7.3A, di/dt \leq 300A/µs, $V_{DD} \leq$ BV $_{DSS}$, Starting T_{J} = 25°C 4. Pulse Test : Pulse width \leq 300µs, Duty cycle \leq 2% 5. Essentially independent of operating temperature

Typical Characteristics

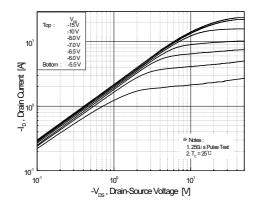


Figure 1. On-Region Characteristics

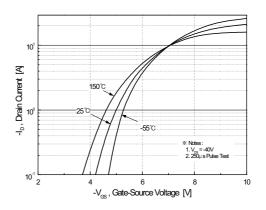


Figure 2. Transfer Characteristics

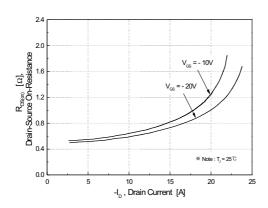


Figure 3. On-Resistance Variation vs. Drain Current and Gate Voltage

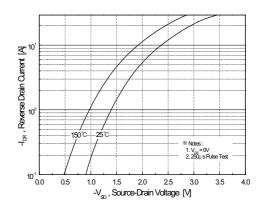


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

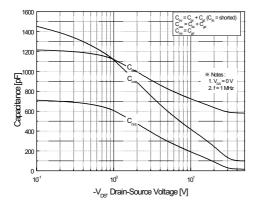


Figure 5. Capacitance Characteristics

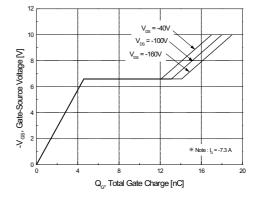


Figure 6. Gate Charge Characteristics

Typical Characteristics (Continued)

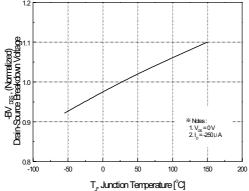


Figure 7. Breakdown Voltage Variation
vs. Temperature

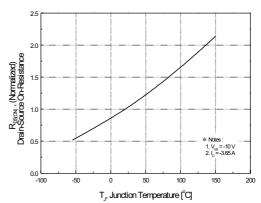


Figure 8. On-Resistance Variation vs. Temperature

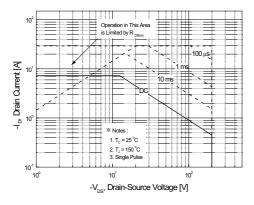


Figure 9. Maximum Safe Operating Area

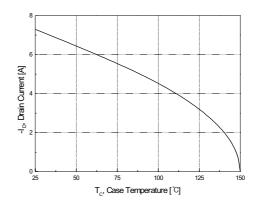


Figure 10. Maximum Drain Current vs. Case Temperature

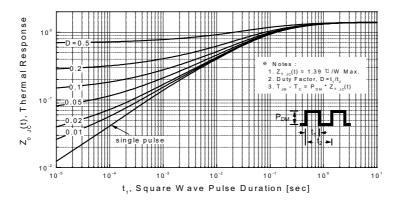
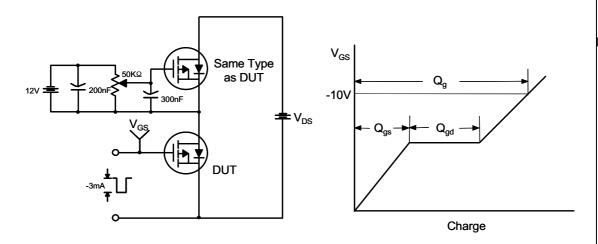
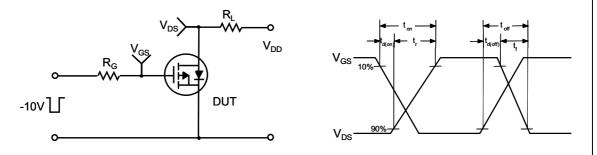


Figure 11. Transient Thermal Response Curve

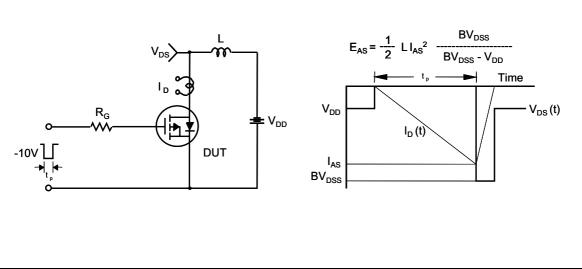
Gate Charge Test Circuit & Waveform



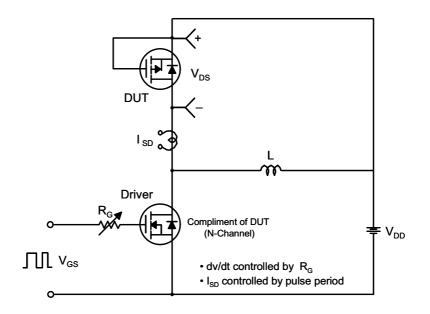
Resistive Switching Test Circuit & Waveforms

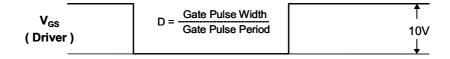


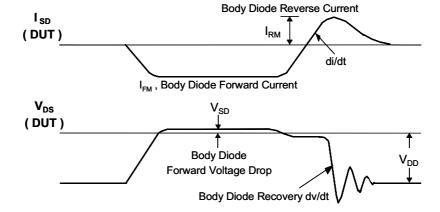
Unclamped Inductive Switching Test Circuit & Waveforms



Peak Diode Recovery dv/dt Test Circuit & Waveforms











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